



BSI Standards Publication

Interoperation guide for field device tool (FDT)/device type manager (DTM) and electronic device description language (EDDL)

National foreword

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TECHNICAL REPORT



**Interoperation guide for field device tool (FDT) / device type manager (DTM) and
electronic device description language (EDDL)**

INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

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CONTENTS

FOREWORD.....	4
INTRODUCTION.....	6
1 Scope.....	7
2 Normative references	7
3 Terms, definitions, and abbreviations	7
3.1 Terms and definitions.....	7
3.2 Abbreviations.....	8
4 Typical methods to convert EDD to FDT/DTM.....	8
4.1 Overview.....	8
4.2 Using a universal DTM to integrate the EDD document.....	9
4.2.1 General	9
4.2.2 Basic contents of the transformation from EDD to DTM.....	9
4.2.3 Procedure.....	10
4.3 Using a converting tool to integrate EDD documents.....	11
4.3.1 General	11
4.3.2 Basic contents	12
4.3.3 Procedure.....	12
4.4 Generate an FDT/DTM based on EDD documents	13
5 General requirements for the conversion from EDD to FDT	13
5.1 Overview.....	13
5.2 Requirements for the agent interpreter.....	13
5.2.1 General	13
5.2.2 Standardized requirements of the basic parameters description	16
5.2.3 Standardized requirements of the fieldbus communication protocol mapping.....	17
5.2.4 Standardized requirements of the device parameters visual description.....	17
5.2.5 Standardized requirements of error handling	18
5.3 The requirements of EDD document format.....	19
5.4 Requirements for EDD storage management.....	19
5.5 The user interface style requirements of FDT/DTM converted from EDDL	20
5.5.1 Overview	20
5.5.2 Basic requirements of the FDT/DTM interface design	20
5.5.3 FDT/DTM user interface	20
5.5.4 FDT/DTM user interface areas.....	21
5.5.5 Parameter handling	24
Annex A (informative) Standard user interface of FDT/DTM	26
Bibliography.....	27
Figure 1 – EDD to DTM conversion flowchart.....	11
Figure 2 – EDD to DTM general process of conversion flowchart	12
Figure 3 – Basic parameter description mapping.....	17
Figure 4 – Communication mapping	17
Figure 5 – User interface mapping	18
Figure A.1 – Specific example of FDT/DTM's standard user interface	26

Table 1 – EDD basic elements 14
Table 2 – The related interfaces of DTM 15
Table 3 – Standard user interface of FDT/DTM 21
Table 4 – Contents of Identification Area 21
Table 5 – Contents of Action Area 22
Table 6 – Elements of the Status Bar 23
Table 7 – Connection states of DTM 23
Table 8 – Data source states 24
Table 9 – States of the instance data set 24
Table 10 – Device diagnostic states 24

INTERNATIONAL ELECTROTECHNICAL COMMISSION

INTEROPERATION GUIDE FOR FIELD DEVICE TOOL (FDT) / DEVICE TYPE MANAGER (DTM) AND ELECTRONIC DEVICE DESCRIPTION LANGUAGE (EDDL)

FOREWORD

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IEC 62795, which is a technical report, has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

The text of this technical report is based on the following documents:

Enquiry draft	Report on voting
65E/240/DTR	65E/330/RVC

Full information on the voting for the approval of this technical report can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

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INTRODUCTION

At present, there are two International Standards for device integration that describe the properties of automation system components to be used in host systems. They are IEC 61804 for electronic device description language (EDDL) and IEC 62453 for field device tools (FDT), with both standards having their own characteristics. The number of manufacturers and users using EDDL or FDT technologies is increasing, and investment in both of them is therefore increasing too.

EDDL technology enables the integration of real product details using the tools of the engineering life cycle and specifies EDDL as a generic language for describing the properties of automation system components. EDDL technology allows to transfer the properties of a device to a data set, called electronic device description (EDD), that can be interpreted by configuration tools in a host system. EDD files, representing the behavior and attributes of a device, can be stored in the field device or control system. The interaction between a field device and a control system uses various communication protocols such as specified in IEC 61784-1, CP 1-1 (FF) or IEC 61784-1, CP 9-1 (HART^{®1}).

FDT is an open and independent software interface specification. An FDT specification describes software interface and relationships within the framework of the project (FDT container, FDT frame applications) and device software components in a Device Type Manager (DTM). An FDT framework is independent from the devices and fieldbus system, while the DTM depends on specific device and fieldbuses.

Both technologies are supported by automation vendors and users, so that there is a need to generate a DTM based on an EDD as long as the field device integration (FDI) technology is not published as an International Standard.

FDI (IEC 62769) covers device integration and device management technology, combining base concepts and technology aspects of the EDDL (IEC 61804), FDT (IEC 62543) and OPC UA (IEC 62541-1). The combination of those different proven technologies ensures a secure life cycle and the ability to address all challenges of device integration and device management in a scalable manner.

EDDL and FDT are complimentary in a way that an EDDL can be converted into an FDT-DTM. As long as FDI is not available, converting EDD into a DTM helps to combine the two standards and use EDDs in an FDT frame environment in case there is no specific DTM available. The conversion criterion is based on EDDL and FDT technologies.

¹ HART[®] is an example of a suitable product available commercially. This information is given for the convenience of users of this document and does not constitute an endorsement by IEC of this product.

INTEROPERATION GUIDE FOR FIELD DEVICE TOOL (FDT) / DEVICE TYPE MANAGER (DTM) AND ELECTRONIC DEVICE DESCRIPTION LANGUAGE (EDDL)

1 Scope

This Technical Report provides the general requirements for converting an EDD into a DTM. Using this TR, an FDT/DTM developer can develop an EDD-DTM conversion tool that can be used to import, parse, and manage EDD to generate the corresponding DTM. A conversion tool versus a DTM written independent of an EDD helps the DTM generation to maintain consistency in function, data and presentation styles.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61804 (all parts), *Function blocks (FB) for process control*

IEC 61804-3:2010, *Function blocks (FB) for process control – Part 3 Electronic Device Description Language (EDDL)*

IEC 62453-1:2009, *Field device tool (FDT) interface specification – Part 1: Overview and guidance*

3 Terms, definitions, and abbreviations

3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 62453-1, IEC 61804-3, as well as the following apply.

3.1.1

agent interpreter

analytical software for parsing EDD

Note 1 to entry: An agent interpreter can parse out the elements in the EDD document and map to the DTM.

Note 2 to entry: An agent interpreter can realize the interaction between the DTM and the physical device.

3.1.2

application

software functional unit that is specific to the solution of a problem in industrial-process measurement and control

Note 1 to entry: An application may be distributed across multiple resources, and may communicate with other applications.

[SOURCE: IEC 61499-1:2005, 3.5]